

Cover Story

Samsung Techwin has been developing advanced technology for electronic & mechanical design, process, and production with high speed and accuracy, leveraging the technical expertise of developing and producing jet engines for aerospace, industrial robots, semiconductor equipment, and opto-electronic machines.

Based on those technologies, the company provides high-speed equipment, next-generation equipment corresponding to package process, and multi-functional instruments with the highest reliability and productivity.

Keeping pace with the current trends of semiconductor package process, Samsung Techwin provides chip mounters for the assembly of printed circuit boards (PCBs) necessary for high-performance electronic products and communication instruments with light weight, thin profiles, and small sizes. Samsung



Technical personnel of Samsung Techwin's Intelligent Machine Solution Division grace the cover of AEI September. From left: Byungju Kim, Senior Research Engineer; Kyungwan Kang, Principle Research Engineer; Hyeeyeon Byun, Research Engineer; Yongjun Kim, Research Engineer; Donyub Cho, Senior Managing Director; Hansu Choi, Research Engineer; Sunjeong Kang, Research Engineer; and Hyunkyuu Ahn, Research Engineer.

Techwin also offers surface-mount technology (SMT) total solution, as well as semiconductor assembly equipment, including automatic flip chip mounters.

Here is Samsung Techwin's SMT

Department General Manager Donyub Cho's message to readers of AEI:

"Thanks to your support, Samsung Techwin was able to achieve No.1 in the medium-speed chip moulder market for the first half of 2013. Amid the global economic recession and this year's uncertainties, our remarkable growth in market share demonstrates that the value of our products in minimizing investment burden and enhancing productivity is being acknowledged by customers."

Cho adds, "We will continue our efforts to increase customer satisfaction and value through the provision of 'fresh energy' and 'new power.' We are looking forward to taking on new challenges and greatly appreciate your continued interest in our products and services. Our ultimate goal is your well-being and happiness. Please look forward to seeing how we shape a better future for all. Thank you."

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